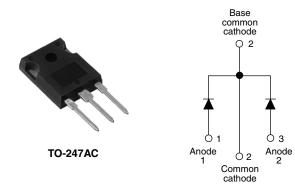


**Vishay Semiconductors** 

## Schottky Rectifier, 2 x 20 A



PRODUCT SUMMARY								
Package	TO-247AC							
I <sub>F(AV)</sub>	2 x 20 A							
V <sub>R</sub>	60 V							
V <sub>F</sub> at I <sub>F</sub>	0.62 V							
I <sub>RM</sub> max.	100 mA at 125 °C							
T <sub>J</sub> max.	150 °C							
Diode variation	Common cathode							
E <sub>AS</sub>	13 mJ							

#### **FEATURES**

- 150 °C T<sub>J</sub> operation
- Very low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance



- RoHS COMPLIANT HALOGEN FREE
- Guard ring for enhanced ruggedness and long term reliability
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)

#### DESCRIPTION

The VS-MBR4060WT... center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS						
I <sub>F(AV)</sub>	Rectangular waveform	40	А						
V <sub>RRM</sub>		60	V						
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	1020	А						
V <sub>F</sub>	20 Apk, $T_J = 125 \ ^\circ C$ (per leg)	0.62	V						
TJ	Range	- 55 to 150	°C						

VOLTAGE RATINGS									
PARAMETER	SYMBOL	VS-MBR4060WTPbF	VS-MBR4060WT-N3	UNITS					
Maximum DC reverse voltage	V <sub>R</sub>	60	60	V					
Maximum working peak reverse voltage	V <sub>RWM</sub>	00	00	v					

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDI	TEST CONDITIONS						
Maximum average pe	r leg	T <sub>C</sub> = 108 °C, 50 % duty cycle, r	rootopgular waveform	20					
forward current per de	vice I <sub>F(AV)</sub>	$T_{\rm C} = 108$ C, 50 % duty cycle, r	40						
Maximum peak one cycle	less.	5 $\mu s$ sine or 3 $\mu s$ rect. pulse	Following any rated load condition and with	1020	A				
non-repetitive surge current per leg	IFSM	10 ms sine or 6 ms rect. pulse	rated V <sub>RRM</sub> applied	265					
Non-repetitive avalanche energy per leg	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 1.5 A, L = 11.5 mH		13	mJ				
Repetitive avalanche current per leg	I <sub>AR</sub>	Current decaying linearly to zer Frequency limited by $T_J$ maxim	1.5	А					

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ELECTRICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS						
Maximum forward voltage drop	V <sub>FM</sub> <sup>(1)</sup>	20 A	T <sub>J</sub> = 25 °C	0.72	V				
Maximum forward voltage drop	VFM (**	20 A	T <sub>J</sub> = 125 °C	0.62	v				
Maximum instantaneous reverse current	I <sub>RM</sub>	T <sub>J</sub> = 25 °C	Rated DC voltage	1.0	mA				
waximum instantaneous reverse current		T <sub>J</sub> = 125 °C	haled DC vollage	100	ША				
Maximum junction capacitance	C <sub>T</sub>	$V_R = 5 V_{DC,}$ (test signal range	$V_R$ = 5 $V_{DC}$ , (test signal range 100 kHz to 1 MHz) 25 °C						
Typical series inductance	L <sub>S</sub>	Measured from top of termi	7.5	nH					
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>	10 000	V/µs					

Note

<sup>(1)</sup> Pulse width < 300  $\mu$ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 150	°C				
Maximum thermal resistance, junction to case per package		R <sub>thJC</sub>	DC operation	2.20					
Typical thermal resistance, case to heatsink		R <sub>thCS</sub> Mounting surface, smooth and greased		1.10	°C/W				
Maximum thermal resistance, junction to ambient		R <sub>thJA</sub>	DC operation	50					
Approvimete weight				6	g				
Approximate weight				0.21	oz.				
Manatiantana	minimum				kgf ⋅ cm				
Mounting torque –	maximum			12 (10)	(lbf ⋅ in)				
Marking device			Case style TO-247AC	MBR40	060WT				



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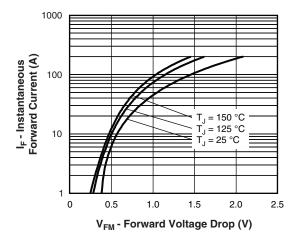


Fig. 1 - Maximum Forward Voltage Drop Characteristics

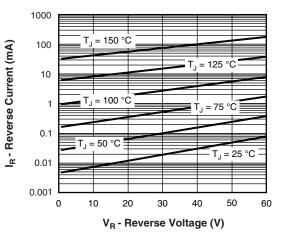


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

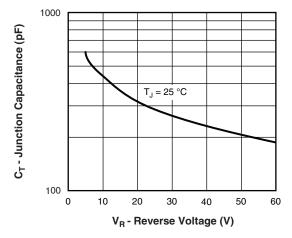


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

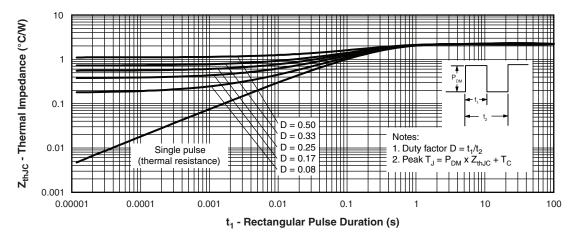
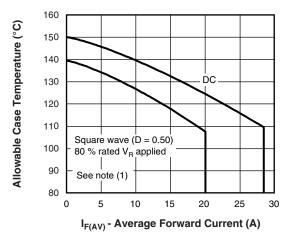
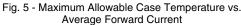


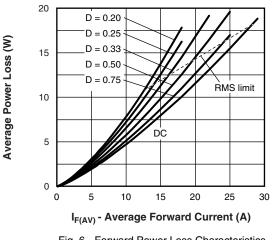
Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics



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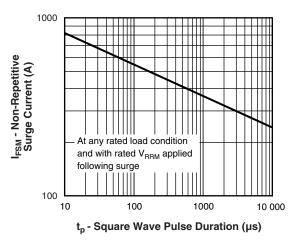


Fig. 7 - Maximum Non-Repetitive Surge Current

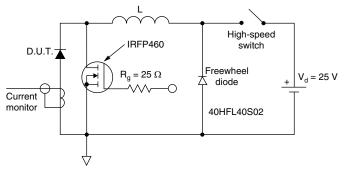


Fig. 8 - Unclamped Inductive Test Circuit

#### Note

 $\begin{array}{ll} \mbox{(1)} & \mbox{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \mbox{Forward power loss} = I_{F(AV)} \times V_{FM} \mbox{ at } (I_{F(AV)}/D) \mbox{ (see fig. 6); } \\ Pd_{REV} = \mbox{Inverse power loss} = V_{R1} \times I_R \mbox{ (1 - D); } I_R \mbox{ at } V_{R1} = 80 \ \% \mbox{ rated } V_R \end{array}$ 

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Vishay Semiconductors

#### **ORDERING INFORMATION TABLE**

Device code	VS-	MBR	40	60	wт	PbF
	1	2	3	4	5	6
	1 - 2 -	Sch	ottky MI	niconduc BR serie	s	duct
	3 - 4 -	· Volt	age rati	ng (40 = ng (60 =	60 V)	
	5 -	Cen	iter tap (	guratior (dual) T( ital digit		
	6 -	• P	bF = Le	ad (Pb)		

• -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION								
VS-MBR4060WTPbF	25	500	Antistatic plastic tube					
VS-MBR4060WT-N3	25	500	Antistatic plastic tube					

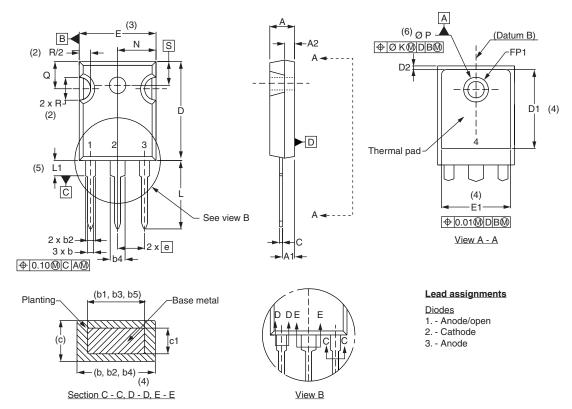
LINKS TO RELATED DOCUMENTS							
Dimensions		www.vishay.com/doc?95223					
Part marking information	TO-247AC PbF	www.vishay.com/doc?95226					
	TO-247AC -N3	www.vishay.com/doc?95007					

### **Outline Dimensions**





#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STNIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209		D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102		E	15.29	15.87	0.602	0.625	3
A2	1.50	2.49	0.059	0.098		E1	13.72	-	0.540	-	
b	0.99	1.40	0.039	0.055		e	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053		FK	2.	54	0.0	)10	
b2	1.65	2.39	0.065	0.094		L	14.20	16.10	0.559	0.634	
b3	1.65	2.37	0.065	0.094		L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135		Ν	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133		ΦP	3.56	3.66	0.14	0.144	
с	0.38	0.86	0.015	0.034		Φ <b>P1</b>	-	6.98	-	0.275	
c1	0.38	0.76	0.015	0.030		Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3	R	4.52	5.49	1.78	0.216	
D1	13.08	_	0.515	-	4	S	5.51	BSC	0.217	BSC	

#### Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

(6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

<sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c

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